

TDB6HK165N16LOF

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Summary

Order

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Order

Sales Product Name	TDB6HK165N16LOF
OPN	TDB6HK165N16LOFHOSA1
Product Status	active and preferred
Package name	AG-ISOPACK
Order online	
Completely lead free	yes
Halogen-free	no
RoHS compliant	yes
Packing Size	3
Packing Type	TRAY
Moisture Level	
Moisture Packing	NON DRY

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FAQ search! Please enter your question... 

Here are 6 common questions answered. Use the search bar above to see more questions answered.

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